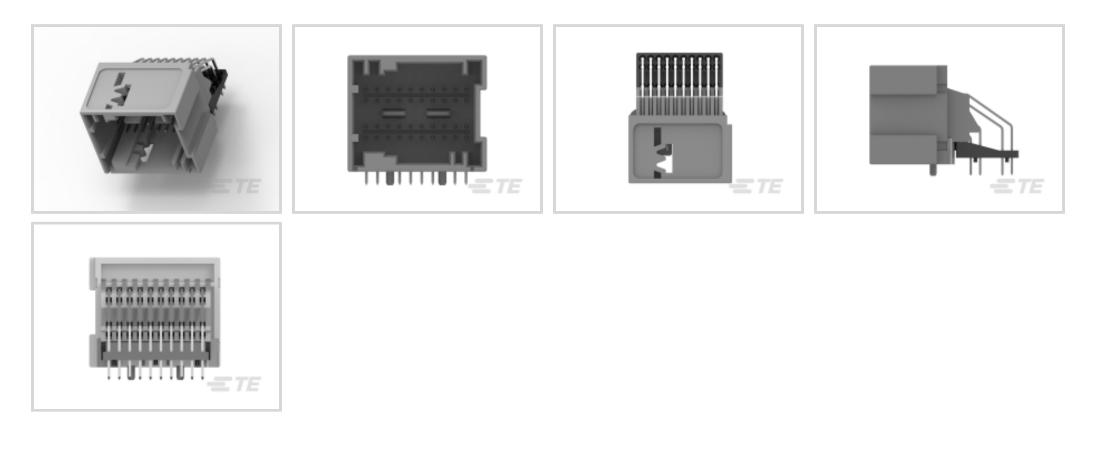


MQS

TE Internal #: 1745060-1 PCB Mount Header, Horizontal, Wire-to-Board, 40 Position, .1 in [2.54 mm] Centerline, Fully Shrouded, Tin (Sn), Through Hole -Solder, Signal, MQS

View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles > SIGNAL HEADER



Connector System: Wire-to-Board

Number of Positions: 40

Centerline (Pitch): 2.54 mm [.1 in]

Sealable: No

PCB Mount Orientation: Horizontal

All SIGNAL HEADER (414)

Connectivity

Features

Product Type Features

Hybrid Header	No	
Connector & Housing Shape	Rectangular	
PCB Connector Assembly Type	PCB Mount Header	
Header Type	Fully Shrouded	
Connector System	Wire-to-Board	
Sealable	No	
Connector & Contact Terminates To	Printed Circuit Board	
Configuration Features		
Number of Sections	1	
Number of Signal Positions	40	
Number of Positions	40	
PCB Mount Orientation	Horizontal	
Number of Rows	4	

S For support call+1 800 522 6752

PCB Mount Header, Horizontal, Wire-to-Board, 40 Position, .1 in [2.54 mm] Centerline, Fully Shrouded, Tin (Sn), Through Hole - Solder, Signal, MQS



Electrical Characteristics		
Nominal Voltage Architecture	12 V	
Operating Voltage	16 VDC	
Body Features		
Primary Product Color	Gray	
Contact Features		
Contact Size	.63mm	
Contact Type	Tab	
Mating Tab Width	.63 mm[.025 in]	
Mating Tab Thickness	.63 mm[.025 in]	
Contact Mating Area Plating Material	Tin (Sn)	
Termination Features		
Termination Method to Printed Circuit Board	Through Hole - Solder	
Mechanical Attachment		
Mounting Holes	With	
Mating Retention	With	
Mating Alignment	With	
PCB Mount Alignment	With	
Panel Mount Feature	With	
PCB Mount Retention	Without	
Mating Retention Type	Locking Interface	
Connector Mounting Type	Panel Mount	
Housing Features		
Centerline (Pitch)	2.54 mm[.1 in]	
Dimensions		
Connector Length	32 mm[1.26 in]	
Connector Width	40.3 mm[1.587 in]	
PCB Thickness (Recommended)	.8 – 1.6 mm[.031 – .063 in]	
Profile Height from PCB	26.7 mm[1.051 in]	
Usage Conditions		
Operating Temperature (Max)	65 °C, 70 °C, 75 °C, 80 °C, 85 °C, 90 °C, 100	

C For support call+1 800 522 6752

07/21/2022 12:58PM | Page 2

PCB Mount Header, Horizontal, Wire-to-Board, 40 Position, .1 in [2.54 mm] Centerline, Fully Shrouded, Tin (Sn), Through Hole - Solder, Signal, MQS



	[194 °F][212 °F]
Operating Temperature Range	-40 - 100 °C[-40 - 212 °F]
Operation/Application	
Shielded	No
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94HB
Packaging Features	
Packaging Type	Loose Piece
Packaging Quantity	160
Other	
Interface Number	953122-6
Product Compliance	
For compliance documentation, visit the product page on TE.com>	Compliant
EU RoHS Directive 2011/65/EU	Compliant
	Compliant
EU RoHS Directive 2011/65/EU EU ELV Directive 2000/53/EC	Compliant No Restricted Materials Above Threshold Current ECHA Candidate List: JUNE 2022 (224)
EU RoHS Directive 2011/65/EU EU ELV Directive 2000/53/EC China RoHS 2 Directive MIIT Order No 32, 2016	Compliant No Restricted Materials Above Threshold Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JAN 20 (223) SVHC > Threshold:
EU RoHS Directive 2011/65/EU EU ELV Directive 2000/53/EC China RoHS 2 Directive MIIT Order No 32, 2016 EU REACH Regulation (EC) No. 1907/2006	CompliantNo Restricted Materials Above ThresholdCurrent ECHA Candidate List: JUNE 2022 (224)Candidate List Declared Against: JAN 20 (223)SVHC > Threshold: Not Yet ReviewedLow Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PV

Product Compliance Disclaimer

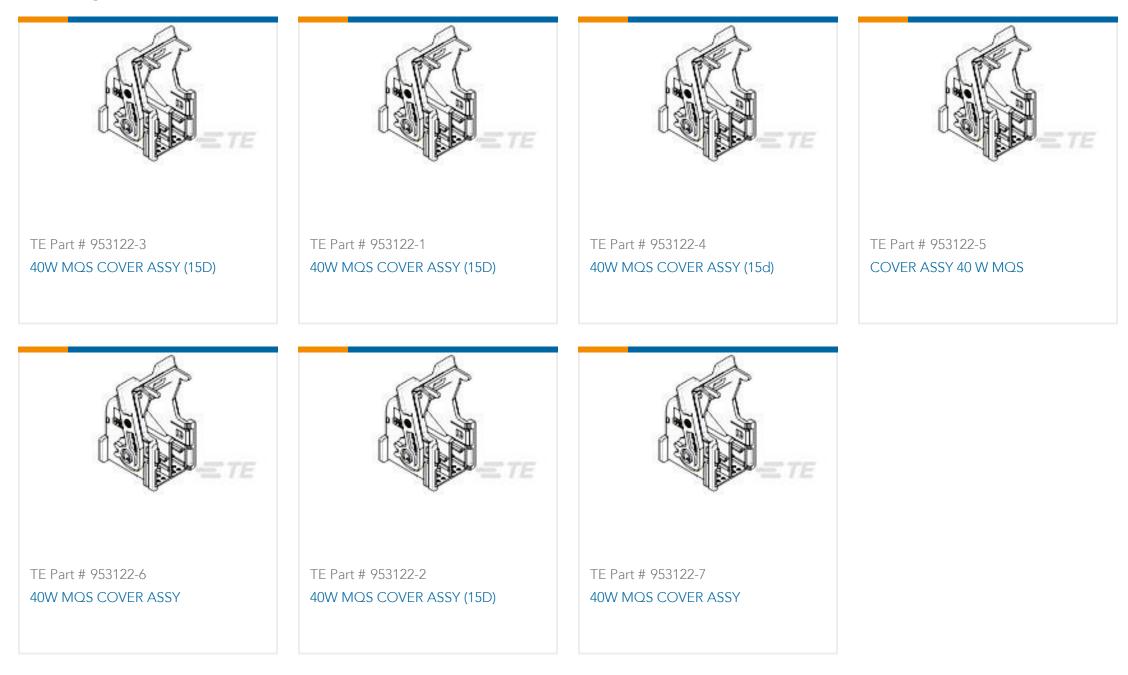
This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides

PCB Mount Header, Horizontal, Wire-to-Board, 40 Position, .1 in [2.54 mm] Centerline, Fully Shrouded, Tin (Sn), Through Hole - Solder, Signal, MQS



on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-onreach

Compatible Parts



Also in the Series MQS



	And		
Automotive Connector Caps & Covers (132)	Automotive Connector EMC Shielding (2)	Automotive Connector Locks & Position Assurance(29)	Automotive Housings(489)
	A CONTRACTION OF THE SECOND OF		
Automotive Seals & Cavity Plugs(26)	Automotive Terminals(96)	Insertion & Extraction Tools(42)	Other Automotive Connector Accessories(13)

PCB Mount Header, Horizontal, Wire-to-Board, 40 Position, .1 in [2.54 mm] Centerline, Fully Shrouded, Tin (Sn), Through Hole - Solder, Signal, MQS





Customers Also Bought



Documents

Product Drawings

40pos MQS .63 header 90deg

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1745060-1_A_c-1745060-1-a.2d_dxf.zip

English

Customer View Model ENG_CVM_CVM_1745060-1_A_c-1745060-1-a.3d_igs.zip English Customer View Model ENG_CVM_CVM_1745060-1_A_c-1745060-1-a.3d_stp.zip English

C For support call+1 800 522 6752

PCB Mount Header, Horizontal, Wire-to-Board, 40 Position, .1 in [2.54 mm] Centerline, Fully Shrouded, Tin (Sn), Through Hole - Solder, Signal, MQS



Product Specifications Product Specification

English

Product Specification

English